

SY58620L

Precision 4.25Gbps CML Backplane Transceiver with Integrated Loopback

General Description

The SY58620L is a low jitter, high-speed transceiver with a variable swing CML transmitter buffer and a CML high-gain receiver optimized for precision telecom and enterprise server transmission line and backplane data management. The SY58620L distributes data to 4.25Gbps guaranteed over temperature and voltage.

The SY58620L transmitter differential input includes Micrel's unique, 3-pin input termination architecture that directly interfaces to any (AC- or DC-coupled) differential signal as small as 100mV ($200mV_{PP}$) without any termination resistor network in the signal path. The receiver differential input is optimized to interface directly to AC-coupled signals as small as 10mV ($20mV_{PP}$). The outputs are 5 Ω source -terminated CML with extremely fast rise/fall time.

To support remote self-testing, the SY58620L features a high-speed loopback test mode. The input control signal LOOPBACK enables an internal loopback path from the transmitter input to the receiver output.

The SY58620L operates from a 3.3V \pm 10% supply and is guaranteed over the full industrial temperature range of -40°C to +85°C. The SY58620L is part of Micrel's high-speed, Precision Edge[®] product line.

All support documentation can be found on Micrel's web site at: <u>www.micrel.com</u>.

Applications

- Backplane management
- Active cable transceivers
- SONET/SDH data/clock applications
- 4X Fibre Channel applications

Typical Applications



Precision Edge is a registered trademark of Micrel, Inc.



Features

- Guaranteed AC performance over temperature and voltage:
 - Maximum Throughput 4.25Gbps
 - <120ps t_r/t_f time
- Transmitter
 - Patented input termination directly interfaces to ACor DC-coupled differential inputs
 - Variable swing CML output
- Receiver
 - 32dB high-gain Input
 - Internal 50Ω input termination
 - Accepts AC-coupled input signals as small as 10mV $(20mV_{\text{PP}})$
 - 400mV ($800mV_{PP}$) differential CML output swing
- Loss-of-Signal (LOS)
 - High-gain, TTL-compatible LOS output with internal $4.75k\Omega$ pull-up
 - Programmable LOS level set
- Ultra-low jitter design
- <5ps_{RMS} random jitter
- Patent-pending MUX isolates the receiver and the transmitter channels minimizing on crosstalk
- Selectable loopback diagnostic mode
- Output enable
- Power supply +3.3V ±10%
- Industrial temperature range -40°C to +85°C
- Available in 24-pin (4mm x 4mm) QFN

Markets

- Precision telecom
- Enterprise server
- ATE
- Test and measurement

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Functional Block Diagram



Note:

It is recommended that $R_{LOSLVL} \le 10 k\Omega$. See the "Typical Operating Characteristics" section for more details.

Ordering Information⁽¹⁾

| Part Number | Package Type | Operating Range | Package Marking | Lead Finish |
|-----------------------------|-----------------|--------------------|--------------------------------------|-------------------|
| SY58620LMG | QFN-24 | Industrial | 620L with Pb-Free bar-line indicator | NiPdAu Pb-Free |
| SY58620LMGTR ⁽²⁾ | QFN-24 | Industrial | 620L with Pb-Free bar-line indicator | NiPdAu Pb-Free |

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^{\circ}C$, DC Electricals only.

2. Tape and Reel.

Pin Configuration



24-Pin QFN

Pin Description

Inputs

| Pin Number | Pin Name | Pin Description |
|------------|-------------|---|
| 23 | LOOPBACK | LOOPBACK Mode Control. TTL/CMOS control input. LOOPBACK is an active HIGH signal used to control the LOOPBACK MUX. LOOPBACK is internally connected to a 25k Ω pull-down resistor and will default to a LOW state if left open. V _{TH} = V _{CC} /2. |
| 20 | /RXEN | Receiver Output Control. TTL/CMOS control input. /RXEN is an active LOW signal used to enable the receiver outputs. /RXEN is internally connected to a $25k\Omega$ pull-down resistor and will default to a LOW state if left open. V _{TH} = V _{CC} /2. |
| 1, 2 | RXIN, /RXIN | Receiver Differential Input. Input accepts AC differential signals as small as 10mV (20mV _{PP}). Each pin internally terminates to V_{CC_RXIN} -1.3V (internal voltage reference) through 50 Ω . Input will default to an indeterminate state if RXIN inputs are left open. See figure 6b. |
| 7 | /TXEN | Transmitter Output Control. TTL/CMOS control input. /TXEN is an active LOW signal used to enable the transmitter output. /TXEN is internally connected to a 25k Ω pull-down resistor and will default to a LOW state if left open. V _{TH} = V _{CC} /2. |
| 14, 13 | TXIN, /TXIN | Transmitter Differential Input. Input accepts AC- or DC-coupled differential signals as small as 100mV (200mV _{PP}). Each pin terminates to the TXVT pin through 50 Ω . Input will default to an indeterminate state if TXIN inputs are left open. See figure 6a. |
| 9 | TXVCTRL | Transmitter Output Swing Control. Input that controls the output amplitude of the transmitter. The operating range of the control input is from V_{REF_CTRL} (max swing) to V_{CC} (min swing). Control of the output swing is obtained with a variable resistor between V_{REF_CTRL} and V_{CC_TXQ} through a wiper driving TXVCTRL. Setting TXVCTRL to V_{CC_TXQ} sets the output swing to min swing. Refer to the "Interface Applications" and "Output Stage" sections for more details. |
| 11 | TXVT | Input Termination Center-Tap. Each side of the transmitter differential input pair terminates to the TXVT pin. The TXVT pin provides a center-tap to a termination network for maximum interface flexibility. Refer to the "Input Stage" section for more details. |

Outputs

| Pin Number | Pin Name | Pin Description |
|------------|-----------|--|
| 22 | LOS | Loss-of-Signal Output. TTL-compatible output with internal $4.75k\Omega$ pull-up resistor. Loss-of-Signal asserts to logic HIGH when the receiver input amplitudes falls below the threshold set by LOSLVL. |
| 19 | LOSLVL | RX Loss-of-Signal Level Set. A resistor (R_{LOSLVL}) connected between LOSLVL and V_{CC} sets the threshold for the data input amplitude at which the LOS output is asserted. Default is max sensitivity. LOSLVL is used to set the Loss-of-Signal (LOS) voltage. It is internally connected to a 2.8k Ω pull-down resistor to an internal V_{REF} voltage source. See "Typical Operating Characteristics," and "Application Implementation" sections for more details. |
| 17, 16 | RXQ, /RXQ | Receiver Differential Output. Output is CML compatible. Refer to the "Truth Table" and "Output Stage" sections for more details. Unused output pair may be left open. The output is designed to drive 400mV ($800mV_{PP}$) into 50Ω to V_{CC} or 100Ω across the pair. |
| 5, 6 | TXQ, /TXQ | Transmitter Differential Variable Swing Output. Output is CML compatible. Please refer to the "Truth Table" and "Output Stage" sections for more details. Unused output pair may be left open. The output is designed to drive $80mV$ ($160mV_{PP}$) min swing to $400mV$ ($800mV_{PP}$) typ. swing into 50Ω to V_{CC_TXQ} or drive 100Ω across the pair depending on TXVCTRL. |
| 8 | VREF_CTRL | Transmitter Output Reference Voltage. Output biases to V_{CC_TXQ} -1.3V. Connecting V_{REF_CTRL} to TXVCTRL sets the transmitter output swing to max swing. |
| 10 | TXVREF-AC | Transmitter Input Reference Voltage. This output biases to V _{CC} -1.3V. It is used when AC coupling the transmitter input. For AC-coupled applications, connect TXVREF-AC to the TXVT pin and bypass with a 0.01 μ F low ESR capacitors to V _{CC} . See "Input Stage" section for more details. Maximum sink/source current is ±1.5mA. |

Power Pins

| Pin Number | Pin Name | Pin Description |
|------------|---------------------|--|
| 3, 24 | GND, Exposed Pad | Ground. GND pins and exposed pad must be connected to the same ground plane. |
| 12, 15, 18 | VCC | $3.3V \pm 10\%$ Positive Power Supply. Bypass with $0.1\mu F//0.01\mu F$ low ESR capacitors and place as close to each V _{CC} pins as possible. Power pins are not connected internally and must be connected to the same power supply externally. |
| 21 | VCC_RXIN | 3.3V ±10% Receive Input Power Supply. Bypass with 0.1 μ F//0.01 μ F low ESR capacitors and place as close to the V _{CC_RXIN} pin as possible. Power pins are not connected internally and must be connected to the same power supply externally. |
| 4 | VCC_TXQ | 3.3V ±10% Output Transmit Power Supply. Bypass with 0.1 μ F//0.01 μ F low ESR capacitors and place as close to the V _{CC_TXQ} pin as possible. Power pins are not connected internally and must be connected to the same power supply externally. |

Truth Table

| LOOPBACK | RXQ | TXQ |
|----------|------|------|
| 0 | RXIN | TXIN |
| 1 | TXIN | RXIN |

Absolute Maximum Ratings⁽¹⁾

| Supply Voltage |
|---|
| (V _{CC} , V _{CC_TXQ} , V _{CC_RXIN})–0.5V to +4.0V |
| Input Voltage |
| LOSLVL V_{REF} –1.2V to V_{CC} |
| LOOPBACK –0.5V to V _{CC} |
| /TXEN, /RXEN –0.5V to V _{CC} |
| TXVCTRLVREF_CTRL-1.2V to V _{CC} |
| TXIN, /TXIN–0.5V to V _{CC} |
| Source or Sink Current on |
| TXVT±100mA |
| LOS±5mA |
| RXQ, /RXQ±25mA |
| TXQ, /TXQ±25mA |
| RXIN, /RXIN±10mA |
| TXIN, /TXIN±50mA |
| TXVREF-AC, VREF-CTRL |
| Lead Temperature (soldering, 20sec.) |
| Storage Temperature (T _s)65°C to +150°C |

Operating Ratings⁽²⁾

| Supply Voltage | |
|---|----------|
| (V _{CC} , V _{CC_TXQ} , V _{CC_RXIN})+3.0V | |
| Ambient Temperature (T _A)40°C | to +85°C |
| Ambient Temperature (T_A) 40°C t Package Thermal Resistance ⁽³⁾ | |
| QFN (θ _{JA}) | |
| Still-Air | .50°C/W |
| QFN (ψ _{JB}) | |
| Junction-to-Board | .30°C/W |

DC Electrical Characteristics⁽⁴⁾

 $T_A = -40^{\circ}C$ to +85°C, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|----------------------|-----------------------|-------------------------------|-----|-----|-----|-------|
| Vcc | Power Supply | | 3 | 3.3 | 3.6 | V |
| V _{CC_TXQ} | Transmit Power Supply | | 3 | 3.3 | 3.6 | V |
| V _{CC_RXIN} | Receive Power Supply | | 3 | 3.3 | 3.6 | V |
| Icc | Power Supply Current | No load, max. V _{CC} | | 100 | 150 | mA |

Receiver Input DC Electrical Characteristics

 $V_{CC RXIN} = 3.3V \pm 10\%$; $T_A = -40$ °C to +85°C, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|----------------------|---|-----------------------------|-------------------------------|-------------------------------|-------------------------------|-------|
| R _{IN} | Input Resistance (RXIN to VREF) | | 45 | 50 | 55 | Ω |
| R _{DIFF_IN} | Input Resistance (RXIN to /RXIN) | | 90 | 100 | 110 | Ω |
| V _{IN} | Input Voltage Swing (RXIN, /RXIN) | See Figure 5a AC-coupled | 10 | | 900 | mV |
| V_{DIFF_IN} | Differential Input Voltage Swing RXIN - /RXIN | See Figure 5b AC-coupled | 20 | | 1800 | mV |
| V_{REF} | Internal Reference Voltage | | V _{CC_RXIN} -1.48 | V _{CC_RXIN} -1.32 | V _{CC_RXIN} -1.16 | V |

Notes:

^{1.} Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

^{2.} The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB. θ_{JA} and ψ_{JB} values are determined for a 4-layer board in still-air, unless otherwise stated.

^{4.} The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

Receiver Output DC Electrical Characteristics

 V_{CC} = 3.3V ±10%, R_L = 100 Ω across the outputs; T_A = -40°C to +85°C, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|-----------------------|---|--|----------------------------|---------------------------|------|-------|
| V _{OH} | Output HIGH Voltage (RXQ, /RXQ) | $R_L = 50\Omega$ to V_{CC} | V _{CC} - 0.020 | V _{CC} -0.010 | Vcc | V |
| V _{OUT} | Output Voltage Swing (RXQ, /RXQ) | See Figure 5a | 325 | 400 | 500 | mV |
| Vdiff_out | Differential Output Voltage Swing (RXQ, /RXQ) | See Figure 5b | 650 | 800 | 1000 | mV |
| R _{OUT} | Single-Ended Output Impedance | | 45 | 50 | 55 | Ω |
| R _{DIFF_OUT} | Differential Output Impedance | | 90 | 100 | 110 | Ω |
| VOFFSET | Differential Output Offset | $R_L = 50\Omega$ to V_{CC} , limiting mode | -140 | | +140 | mV |

Transmitter Input DC Electrical Characteristics

 V_{CC} = 3.3V ±10%; T_A = -40°C to +85°C, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|------------------------------|---|---------------|----------------------|----------------------|---|-------|
| R _{IN} | Input Resistance (TXIN to TXVT) | | 45 | 50 | 55 | Ω |
| R _{DIFF_IN} | Differential Input Resistance (TXIN to /TXIN) | | 90 | 100 | 110 | Ω |
| V _{IH} | Input HIGH Voltage (TXIN, /TXIN) | | 1.2 | | V _{CC} | V |
| VIL | Input LOW Voltage (TXIN, /TXIN) | | 0 | | V _{IH} -0.1 | V |
| V _{IN} | Input Voltage Swing (TXIN, /TXIN) | See Figure 5a | 0.1 | | V _{CC} | V |
| V_{DIFF_IN} | Differential Input Voltage Swing TXIN - /TXIN | See Figure 5b | 0.2 | | | V |
| V _{T_IN} | TXIN, /TXIN to VT | | | | 1.28 | V |
| V _{TXVREF-AC} | Output Reference Voltage | | V _{CC} -1.4 | V _{CC} -1.3 | V _{cc} -1.2 | V |
| $V_{\text{REF}_\text{CTRL}}$ | Output Reference Voltage | | V _{CC} -1.4 | V _{CC} -1.3 | V _{cc} -1.2 | V |
| V _{TXVCTRL} | Input Voltage | | VREF_CTRL | | VCC | V |
| | (TXVCTRL) | | | | V _{CC} V _{IH} -0.1 V _{CC} 1.28 V _{CC} -1.2 V _{CC} -1.2 | |

Transmitter Output DC Electrical Characteristics

 V_{CC_TXQ} = 3.3V ±10%, R_L = 100 Ω across the outputs; T_A = -40°C to +85°C, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|-----------------------|--|--|--------------------------------|--------------------------------|---------------------|-------|
| V _{OH} | Output HIGH Voltage (TXQ, /TXQ) | $R_L = 50\Omega$ to V_{CC_TXQ} | V _{CC_TXQ} - 0.020 | V _{CC_TXQ} - 0.005 | V _{CC_TXQ} | V |
| V _{OUT} | Output Voltage Swing (TXQ, /TXQ) | TXVCTRL = V _{REF_CTRL} See Figure 5a | 325 | 400 | | mV |
| | | TXVCTRL = V _{CC_TXQ} See Figure 5a | | 80 | | mV |
| V_{DIFF_OUT} | Differential Output Voltage Swing (TXQ, /TXQ) | TXVCTRL = V _{REF_CTRL} See Figure 5b | 650 | 800 | | mV |
| | | TXVCTRL = V _{CC_TXQ} See Figure 5b | | 160 | | mV |
| R _{OUT} | Single-Ended Output Impedance | | 45 | 50 | 55 | Ω |
| R _{DIFF_OUT} | Differential Output Impedance | | 90 | 100 | 110 | Ω |

LVTTL/CMOS INPUT DC Electrical Characteristics⁽⁵⁾

 V_{CC} = 3.3V ±10%; T_{A} = –40°C to +85°C, unless otherwise stated.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|-----------------|------------------------|----------------------------|-----|-----|-----|-------|
| VIL | /TXEN, /RXEN, LOOPBACK | | | | 0.8 | V |
| V _{IH} | /TXEN, /RXEN, LOOPBACK | | 2 | | | V |
| IIL | /TXEN, /RXEN, LOOPBACK | $I_{IL}@V_{IN} = 0.5V$ | 0 | | 50 | μA |
| I _{IH} | /TXEN, /RXEN, LOOPBACK | $I_{IH} @ V_{IN} = V_{CC}$ | | | 300 | μA |

Note:

5. /TXEN, /RXEN, and LOOPBACK have an internal pull-down 25k Ω resistor.

LOS DC Electrical Characteristics

 $V_{CC} = 3.3V \pm 10\%$; $T_A = -40^{\circ}C$ to +85°C.

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|-------------------|----------------------------|---|-----------|-----|-----|-----------|
| VLOSLVL | LOSLVL Voltage Range | | V_{REF} | | Vcc | V |
| V _{OH} | Output HIGH Voltage | $I_{SOURCE} = -100 \mu A; V_{CC} \ge 3.3 V$ | 2.4 | | | V |
| V _{OL} | Output LOW Voltage | $I_{OL} = 2mA$ | | | 0.5 | V |
| VSR | LOS Sensitivity Range | | 7 | | 35 | mV_{PP} |
| LOS _{AL} | Low LOS Assert Level | $R_{LOSLVL} = 10k\Omega$ 2 ⁷ -1 Data Pattern, Note 7 | | | | |
| | | 622Mbps | | 15 | | mV |
| | | 4.25Gbps | | 10 | | mV |
| LOS _{DL} | Low LOS De-assert Level | $R_{LOSLVL} = 10k\Omega$ 2 ⁷ -1 Data Pattern, Note 7 | | | | |
| | | 622Mbps | | 20 | | mV |
| | | 4.25Gbps | | 15 | | mV |
| HYS∟ | Low LOS Hysteresis | $R_{LOSLVL} = 10k\Omega$, limiting mode 2^7 -1 Data Pattern, Note 6 and 7 | | | | |
| | | 622Mbps | | 3 | | dB |
| | | 4.25Gbps | | 5.5 | | dB |
| LOS _{AM} | Medium LOS Assert Level | $R_{LOSLVL} = 5k\Omega$ 2 ⁷ -1 Data Pattern, Note 7 | | | | |
| | | 622Mbps | | 20 | | mV |
| | | 4.25Gbps | | 15 | | mV |
| LOS _{DM} | Medium LOS De-assert Level | $R_{LOSLVL} = 5k\Omega$ 2 ⁷ -1 Data Pattern, Note 7 | | | | |
| | | 622Mbps | | 30 | | mV |
| | | 4.25Gbps | | 25 | | mV |
| HYS _M | Medium LOS Hysteresis | $R_{LOSLVL} = 5k\Omega$, limiting mode 2^7 -1 Data Pattern, Note 6 and 7 | | | | |
| | | 622Mbps | | 4 | | dB |
| | | 4.25Gbps | | 5.5 | | dB |
| LOS _{AH} | High LOS Assert Level | $R_{LOSLVL} = 1k\Omega$ 2 ⁷ -1 Data Pattern, Note 7 | | | | |
| | | 622Mbps | | 35 | | mV |
| | | 4.25Gbps | | 30 | | mV |
| LOS _{DH} | High LOS De-assert Level | $R_{LOSLVL} = 1kΩ$ 2 ⁷ -1 Data Pattern, Note 7 | | | | |
| | | 622Mbps | | 60 | | mV |
| | | 4.25Gbps | | 55 | | mV |
| HYSH | High LOS Hysteresis | $R_{LOSLVL} = 1k\Omega$, limiting mode 2^{7} -1 Data Pattern, Note 6 and 7 | | | | |
| | | 622Mbps | | 5 | | dB |
| | | 4.25Gbps | | 5.5 | | dB |

Notes:

6. Hysteresis is defined as: $20Log_{10}\left(\frac{SD_AssertVoltage}{SD_De-assertVoltage}\right)dB.$

See the "Typical Operating Characteristics" section for more details on R_{LOSLVL} and its associated LOS assert and de-assert amplitudes for a 2⁷-1 PRBS data pattern. See the "PRBS Discussion" section for more details on the 2⁷-1 PRBS data pattern.

AC Electrical Characteristics⁽⁸⁾

 $V_{CC} = V_{CC_TXQ} = V_{CC_RXIN} = 3.3V \pm 10\%$, $R_L = 100\Omega$ across the outputs; $T_A = -40^{\circ}C$ to +85°C, unless otherwise stated. **Receiver and Transmitter**

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|-----------------|---------------------------|-----------|-----|-----|---------|-------------------|
| | Deterministic Jitter (DJ) | Note 9 | | | Note 13 | ps _{PP} |
| t JITTER | Random Jitter (RJ) | Note 10 | | 0.7 | 5 | ps _{RMS} |
| | Crosstalk-Induced Jitter | Note 11 | | | 1.2 | ps _{RMS} |

Receiver

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|---------------------------------|---------------------------------------|-----------------------------------|-------|-----|------|-------|
| F _{MAX} | Maximum Operating Frequency | $V_{RXIN} \ge 10 mV (20 mV_{PP})$ | 4.25 | | | Gbps |
| BW | -3dB | $V_{RXIN} \ge 10 mV (20 mV_{PP})$ | | 2.5 | | GHz |
| S ₂₁ | Single-Ended Gain | Linear mode | | 32 | | dB |
| A _{V(DIFF)} | Differential Voltage Gain | Linear mode | | 38 | | dB |
| t _r , t _f | Output Rise/Fall Time (20% to 80%) | Limiting mode | | 60 | 120 | ps |
| LOS Frequency Range | LOS Operating Frequency Range | Note 12 | 0.622 | | 4.25 | Gbps |
| t _{OFF} | LOS De-assert Time | | | 0.1 | 0.5 | μs |
| t _{ON} | LOS Assert Time | | | 0.2 | 0.5 | μs |

Transmitter

| Symbol | Parameter | Condition | Min | Тур | Max | Units |
|---------------------------------|---------------------------------------|--|------|-----|-----|-------|
| F _{MAX} | Maximum Operating Frequency | $V_{TXIN} \ge 100 mV (200 mV_{PP})$ | 4.25 | | | Gbps |
| BW | -3dB | $V_{REF_CTRL} \le TXCTRL \le V_{CC_TXQ}$ | | 3.5 | | GHz |
| t _r , t _f | Output Rise/Fall Time (20% to 80%) | V _{TXVCTRL} = VREF_CTRL | | 50 | 120 | ps |

Notes:

8. High-frequency AC-parameters are guaranteed by design and characterization.

Deterministic jitter is measured with both K28.5 and 2²³-1 PRBS data-pattern, measured at <f_{MAX}. V_{IN} = 10mV (20mVpp) RX, 100mV (200mVpp) TX. See the "PRBS Discussion" section for more details on the K28.5 and 2²³ – 1 PRBS data pattern.

Random jitter is measured with a K28.7 comma detect character pattern, measured at <f_{MAX}. V_{IN} = 10mV (20mVpp) RX, 100mV (200mVpp) TX. See the "PRBS Discussion" section for more details on the K28.7 PRBS data pattern.

11. Crosstalk is measured at the output while applying two similar differential clock frequencies that are asynchronous with respect to each other at the inputs.

12. LOS is guaranteed to be chatter-free at $f_{MAX} \ge 622Mpbs$ or $f_{MAX} \ge 311MHz$ with $V_{RXIN} \ge 10mV$ ($20mV_{PP}$) with a 2^7 -1 PRBS data pattern.

13. Contact factory for limits.

Detailed Description

Receiver

The receiver AC-coupled differential input distributes data to 4.25Gbps with signals as small as 10mV ($20mV_{PP}$) or as large as 900mV ($1.8V_{PP}$). The receiver input features an internal 50 Ω input termination connected to an internal reference which optimizes the inputs for AC-coupled signals. Input signals are linearly amplified with 38dB of differential gain and the output signal is limited to 400mV ($800mV_{PP}$).

The receiver output buffer features 50Ω source termination resistors and a current source that provides 400mV ($800mV_{PP}$) swing into 50Ω termination. The output buffer terminates to standard CML loads (100Ω across the output pair or equivalent). See the "Output Stage Receiver" section for more details.

Transmitter

The transmitter differential input includes Micrel's unique, patented 3-pin input termination architecture that directly interfaces to any (AC- or DC-coupled) differential signal as small as 100mV ($200mV_{PP}$) without any termination resistor network in the signal path.

The transmitter output buffer terminates to standard CML loads (100Ω across the output pair, or equivalent). The output buffer is a special variable swing CML buffer controlled by TXVCTRL. The output buffer features 50Ω source termination and a current source that provides 400mV (800mV_{PP}) swing into 50Ω transmission lines. See the next section and Figures 1a and 1b for more details on how to control the variable output swing feature.



Figure 1a. Voltage Source Implementation



Figure 1b. Alternative Implementation

Transmitter CML Variable-Swing Output Buffer

- Connecting V_{REF_CTRL} to TXVCTRL sets the transmitter output buffer to maximum swing
- Setting TXVCTRL to V_{CC_TXQ}, sets the transmitter output buffer to minimum swing
- Control of the transmitter output buffer swing can be obtained by using a variable resistor connected between V_{REF_CTRL} and V_{CC_TXQ} with a wiper connected to TXVCTRL as shown in Figure 1b

Receiver LOS

The SY58620L features a chatter-free Loss-of-Signal (LOS) TTL compatible output with an internal 4.75kΩ pull-up resistor. LOS circuitry monitors the input receiver signal and asserts a signal when the input signal falls below the threshold set by the programmable LOS level set pin (LOSLVL). When the amplitude of the receiver input signal falls below the threshold, LOS is asserted HIGH with a response time of ~0.2uS. LOS can be fed into /RXEN to maintain output stability by disabling the output during a Lossof-Signal condition. Figure 2a and 2b shows the LOS connection to /RXEN. When /RXEN is HIGH, the output signal RXQ is held LOW and /RXQ is held HIGH. Typically, 2dB of LOS hysteresis is adequate to prevent the receiver output from chattering. LOS operation is optimized for data rates ≥622Mbps with an input receiver amplitude of at least 10mV (20mV_{PP}) . Due to the long time constant in slower data rates below 622Mbps, the SY58620L LOS function does not guarantee chatter-free operation for low amplitude signals.

LOSLVL sets the threshold of the LOS input amplitude detection. Connecting an external resistor, R_{LOSLVL} , between VCC and LOSLVL sets the input amplitude

LOS detection trip-point by setting up a voltage divider between VCC and V_{REF} (an internal voltage source set at V_{CC} -1.3V), since there is a 2.8k Ω internal resistor connected between LOSLVL and V_{REF} . The input voltage range of LOSLVL ranges from V_{CC} to V_{REF} . See the "Functional Block Diagram" section and Figures 2a and 2b, to see how R_{LOSLVL} sets up a voltage divider between VCC and V_{REF} . Refer to the "LOS Output DC Electrical Characteristics" table and "Typical Operating Characteristics" section to see how different R_{LOSLVL} values affect LOS sensitivity.



Figure 2a. Voltage Source Implementation



Figure 2b. Alternative Implementation

LOS Output

- Connecting the input /RXEN to the LOS output as shown in Figures 2a and 2b, maintains receiver output stability under a Loss-of-Signal condition
- Sensitivity of the LOS signal can be programmed using the LOSLVL input by using a variable resistor connected to VCC with a wiper connected to LOSLVL, as shown in Figure 2b

- \geq 2dB hysteresis is insured if R_{LOSLVL} \leq 10k Ω .
- LOS is guaranteed chatter-free at f ≥ 622Mbps (311MHz)

Hysteresis

The SY58620L provides a minimum of 2dB of LOS hysteresis, see the Figure 3 for more details.



Figure 3. LOS Hysteresis Assert/De-assert

Hysteresis is defined as:
$$20Log_{10}\left(\frac{SD_AssertVoltage}{SD_De-assertVoltage}\right)dB.$$

Loopback

To support diagnostic system testing, the SY58620L features a loopback test mode, activated by setting LOOPBACK to logic HIGH. Loopback mode enables an internal loopback path from the transmitter input to the receiver output and supports the full 4.25Gbps data rate throughput.

Crosstalk

The SY58620 features a patent-pending isolation between the receiver and transmitter channels. The following guide lines can be used to minimize on layout induced crosstalk:

1. Ground Stripping

Ground stripping is an effective method to reduce crosstalk. Ground stripping involves running a ground trace between the receiver and transmitter channels.

2. Vertical and Horizontal Traces

Another way to reduce crosstalk is to route the receiver and transmitter channels on separate layers with an embedded ground or power supply layer between the layers. When routing the traces on different layers, run the receiver traces horizontal to the transmitter traces and route the transmitter traces vertical to the receiver traces.

PRBS Discussion

LOS Testing

The LOS function is tested with a 2^7 -1 PRBS (Pseudo Random Bit Stream) data pattern. A PRBS data pattern of 2^7 -1 is used because it is a good approximation to an 8b10b-encoded NRZ data stream. 8b10b encodes 8 bits of data and replaces it with 10 bits of symbol. The extra bits are added to improve transition density and the BER (Bit Error Rate) of the system.

Deterministic Jitter Testing and the K28.5 Pattern

The K28.5 (11000001010011111010) and 2²³-1 PRBS data patterns are used to characterize DJ because both data patterns have lower spectral frequency content which provides a best approximation to scrambled NRZ data streams.

Random Jitter Testing and the K28.7 Pattern

The K28.7 (1111100000...) data pattern is used to measure RJ since the pattern is free of DJ. In addition, because the K28.7 data pattern can be used to compare the T_N (NTH period) to the T_0 (1st period), low frequency jitter components can be accumulated.

Power Supply Filtering

Although the SY58620L is fully differential, it is recommended that the power supplies are filtered as shown in Figure 4.



Figure 4. Power Supply Filtering Scheme

| Item | Description |
|---------------------------------|-----------------------------|
| C1, C2, C3, C23 0.1µF Capacitor | |
| C4, C5, C6, C22 | 0.01µF Capacitor |
| L1, L2, L3 | 1.2µH Ferrite Bead Inductor |

Table 1. Bill of Materials

Typical Operating Characteristics

 $V_{CC} = V_{CC_TXQ} = V_{CC_RXIN} = 3.3V \pm 10\%$, $R_L = 100\Omega$ across the outputs; $T_A = 25^{\circ}C$, unless otherwise stated.



Single-Ended and Differential Swings



Figure 5a. Single-Ended Voltage Swing

Differential Input Stage



Figure 6a. TX Simplified Differential Input Stage



Figure 5b. Differential Voltage Swing



Figure 6b. RX Simplified Differential Input Stage

Output Stage Receiver



Figure 7a. Receiver CML DC-Coupled Output



Figure 7b. Receiver CML AC-Coupled Output



Figure 7c. Receiver CML DC-Coupled Output (50 Ω to V_{cc})

Transmitter



Interface Applications



Figure 8a. LVPECL Interface

(TX DC-Coupled/RX AC-Coupled)



For V_{CC} = 3.3V, R_{pd} = 100 Ω .

Figure 8b. LVPECL Interface (TX AC-Coupled/RX AC-Coupled)



Figure 8c. CML Interface (TX DC-Coupled/RX AC-Coupled)



Figure 8d. CML Interface (TX AC-Coupled/RX AC-Coupled)



Figure 8e. LVDS Interface (TX DC-Coupled/RX AC-Coupled)

Related Product and Support Documentation

| Part Number | Function | Data Sheet Link |
|---------------|---|--|
| SY58621L | Precision 3.2 Gbps CML/LVPECL Transceiver with Integrated Loopback | www.micrel.com/product-info/products/sy58621I.shtml |
| HBW Solutions | New Products and Applications | www.micrel.com/product-info/products/solutions.shtml |

Package Information



A CHAMFER STYLE PIN 1 IDENTIFIER ON BOTTOM SIDE

24-Pin QFN

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